

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
110V	1.1mΩ@10V	375A



**合肥矽普半导体**

Siliup Semiconductor Technology Co., Ltd

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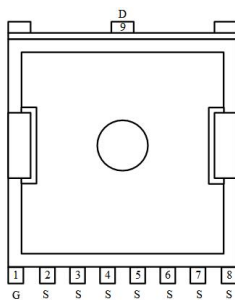
## Feature

- Fast Switching
- Low Gate Charge and Rdson
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

## Applications

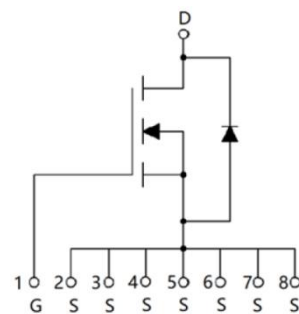
- PWM Application
- Hard switched and high frequency circuits
- Power Management

## Package

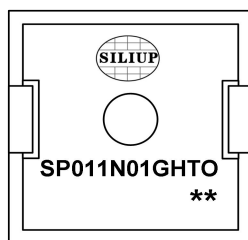


TOLL

## Circuit diagram



## Marking



SP011N01GHTO : Product code  
\*\* : Week code

## Order Information

Device	Package	Unit/Tape
SP011N01GHTO	TOLL	2000

**Absolute maximum ratings (Ta=25°C unless otherwise noted)**

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	110	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current (Tc=25°C)	$I_D$	375	A
Continuous Drain Current (Tc=100°C)	$I_D$	250	A
Pulsed Drain Current	$I_{DM}$	1500	A
Single Pulse Avalanche Energy <sup>1</sup>	$E_{AS}$	2250	mJ
Power Dissipation (Tc=25°C)	$P_D$	396	W
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	0.31	°C/W
Storage Temperature Range	$T_{STG}$	-55 to 150	°C
Operating Junction Temperature Range	$T_J$	-55 to 150	°C

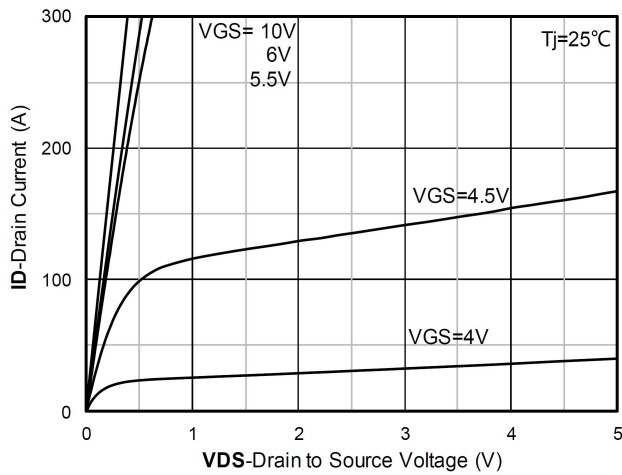
**Electrical characteristics (Ta=25°C, unless otherwise noted)**

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	VGS=0V , ID=250uA	110	-	-	V
Drain Cut-Off Current	IDSS	VDS=90V , VGS=0V , TJ=25℃	-	-	1	μA
Gate Leakage Current	IGSS	VGS=±20V , VDS=0V	-	-	±100	nA
Gate Threshold Voltage	VGS(th)	VGS=VDS , ID =250uA	2.0	3.0	4.0	V
Drain-Source ON Resistance	RDS(ON)	VGS=10V , ID=50A	-	1.1	1.4	mΩ
Dynamic Characteristics						
Input Capacitance	Ciss	VDS=55V , VGS=0V , f=1MHz	-	12700	-	pF
Output Capacitance	Coss		-	3400	-	
Reverse Transfer Capacitance	Crss		-	137	-	
Total Gate Charge	Qg	VDS=55V , VGS=10V , ID=100A	-	216	-	nC
Gate-Source Charge	Qgs		-	68	-	
Gate-Drain Charge	Qgd		-	69	-	
Switching Characteristics						
Turn-On Delay Time	td(on)	VDD=55V, VGS=10V , RG=6Ω, ID=100A	-	81	-	nS
Rise Time	tr		-	176	-	
Turn-Off Delay Time	td(off)		-	165	-	
Fall Time	tf		-	62	-	
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	VSD	Is = 1A, VGS = 0V	-	-	1.2	V
Maximum Body-Diode Continuous Current	Is		-	-	375	A
Reverse Recovery Time	Trr	Is=100A, di/dt=100A/us, TJ=25℃	-	87	-	nS
Reverse Recovery Charge	Qrr		-	201	-	nC

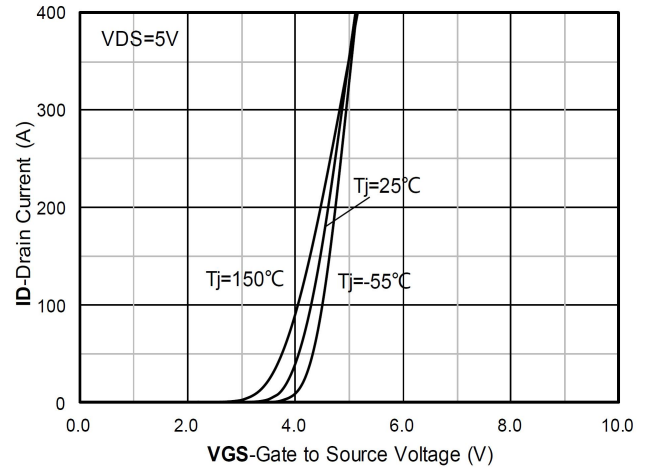
**Note :**

1. The test condition is  $V_{DD}=50V, V_{GS}=10V, L=0.5mH, R_G=25\Omega$

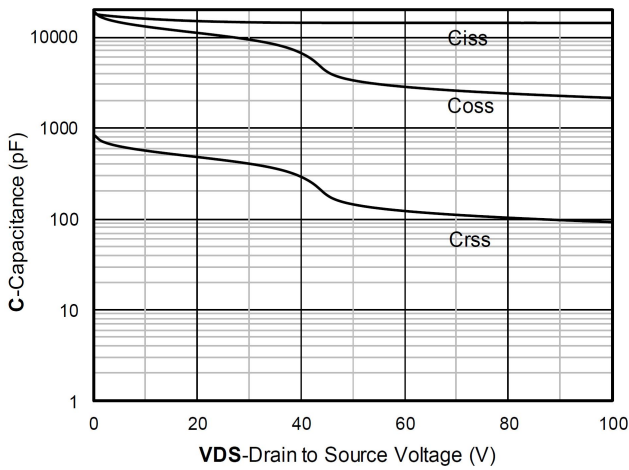
## Typical Characteristics



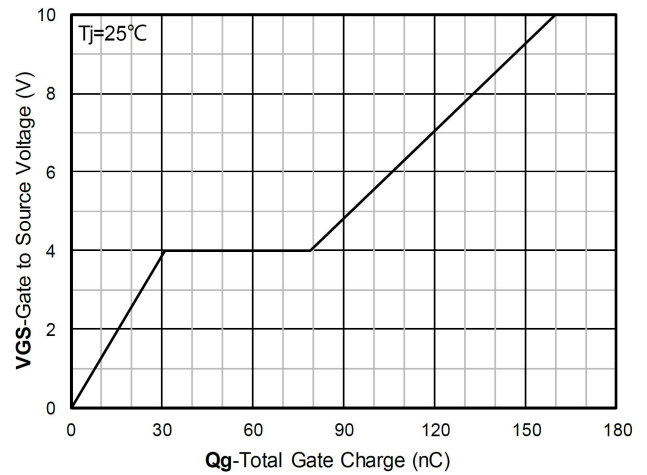
Output Characteristics



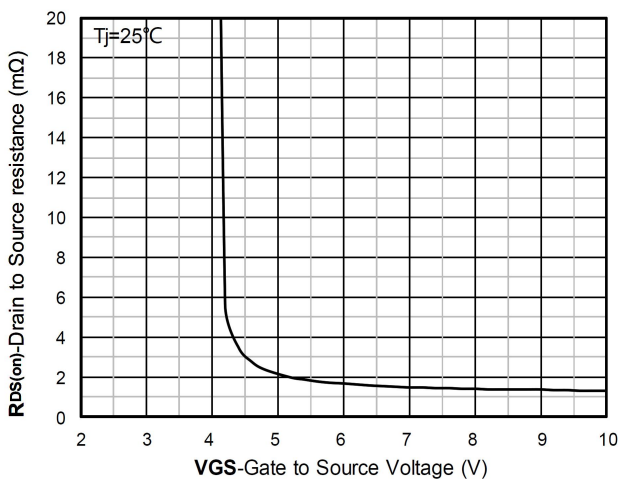
Transfer Characteristics



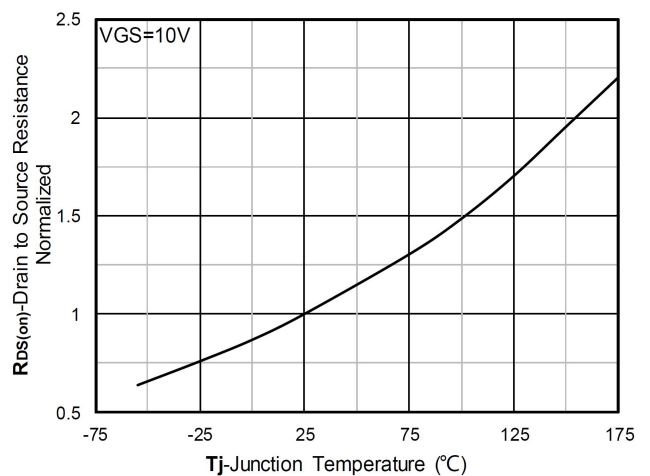
Capacitance Characteristics



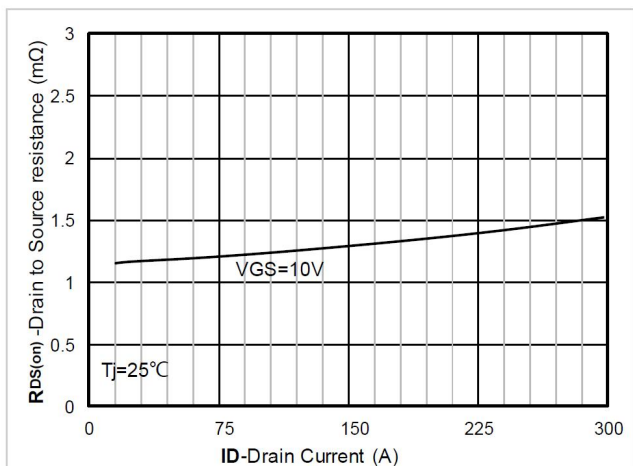
Gate Charge



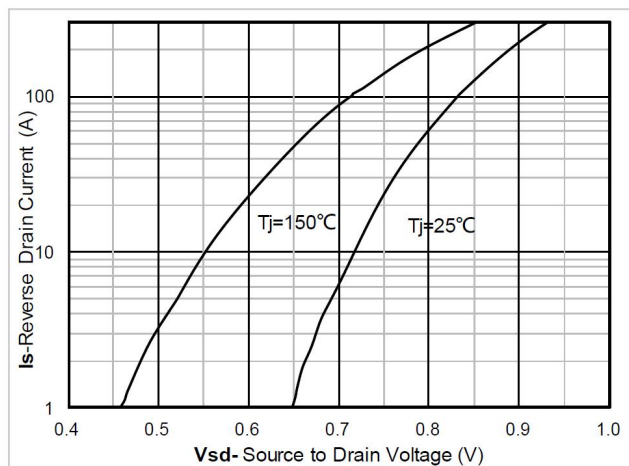
On-Resistance vs Gate to Source Voltage



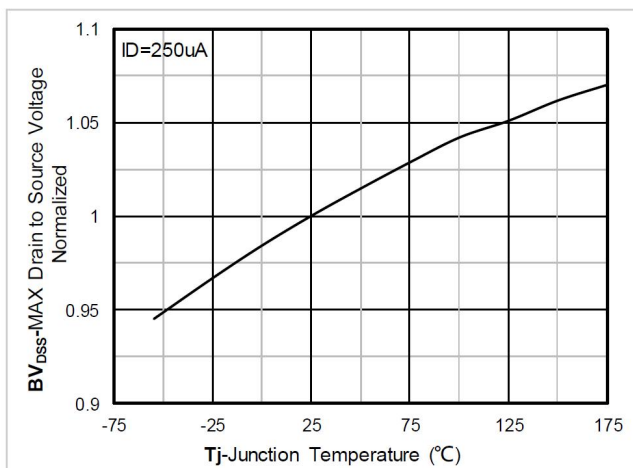
Normalized On-Resistance



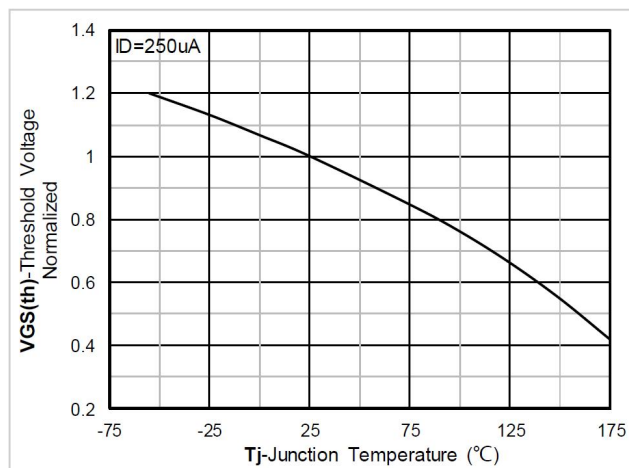
RDS(on) VS Drain Current



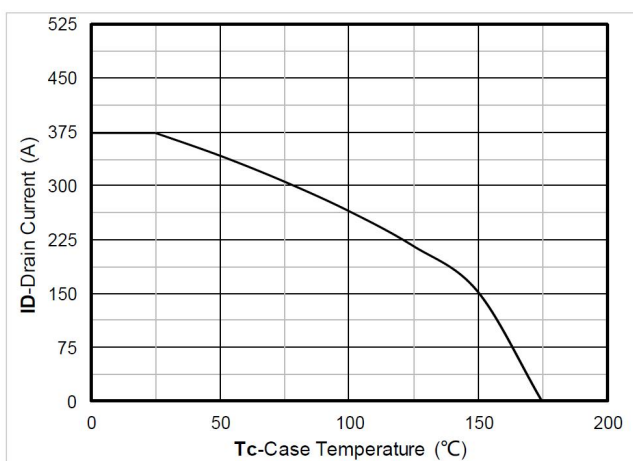
Forward characteristics of reverse diode



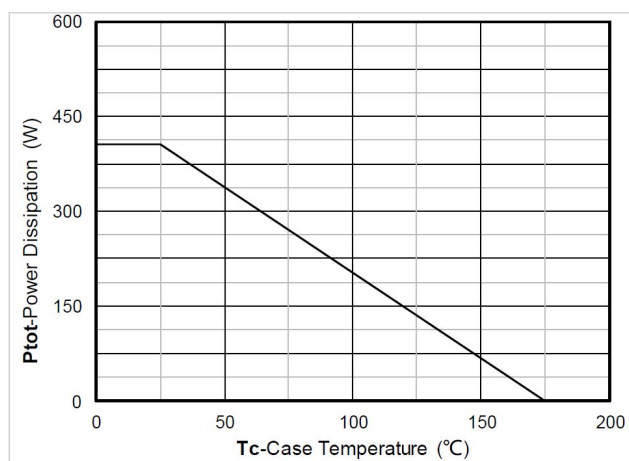
Normalized breakdown voltage



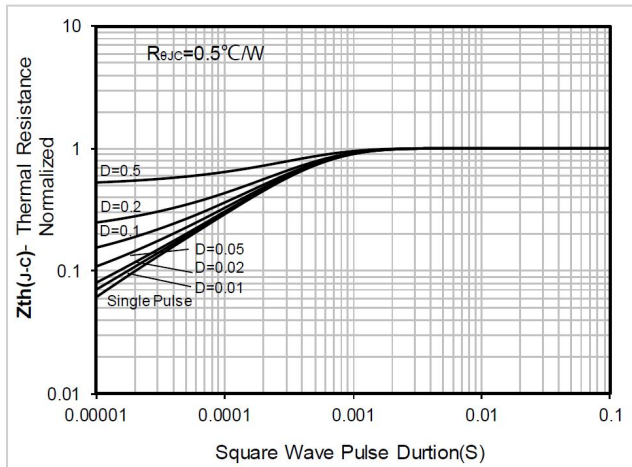
Normalized Threshold voltage



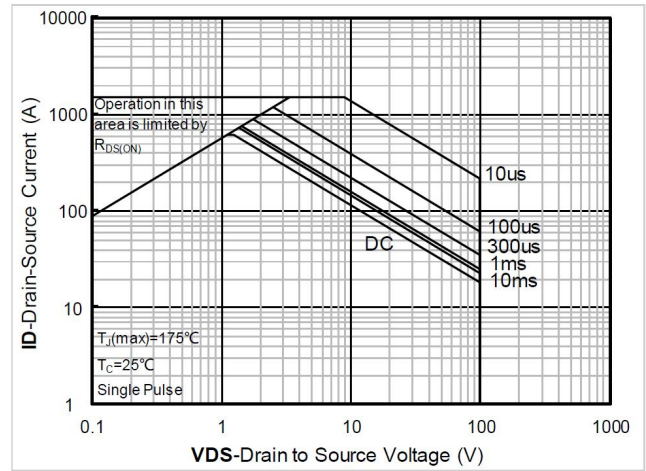
Current dissipation



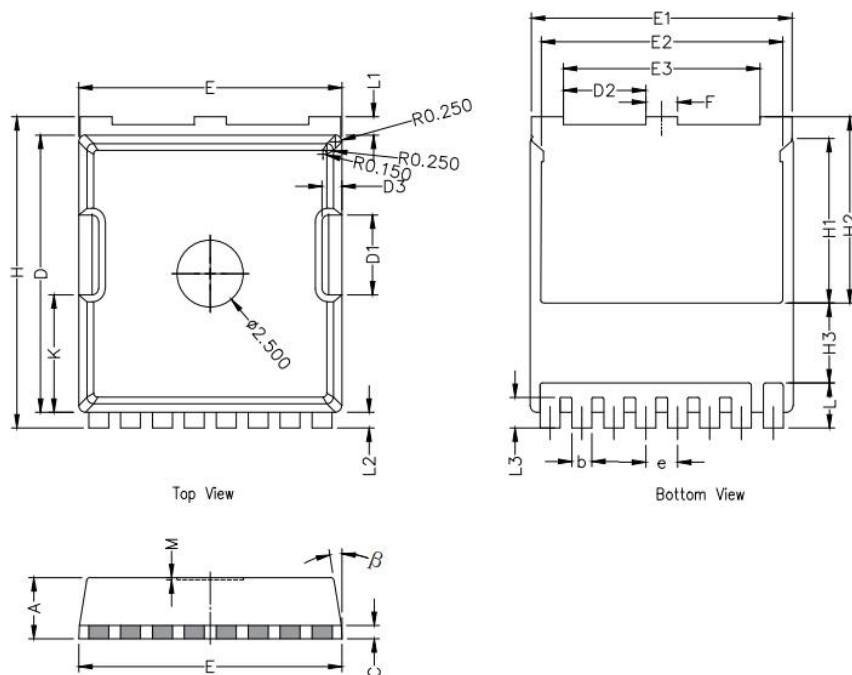
Power dissipation



Maximum Transient Thermal Impedance



Safe Operation Area

**TOLL Package Information**


Symbol	Dimensions In Millimeters		
	Min.	Nom.	Max.
A	2.20	2.30	2.40
b	0.65	0.75	0.85
C	0.508 REF		
D	10.25	10.40	10.55
D1	2.85	3.00	3.15
E	9.75	9.90	10.05
E1	9.65	9.80	9.95
E2	8.95	9.10	9.25
E3	7.25	7.40	7.55
e	1.20 BSC		
F	1.05	1.20	1.35
H	11.55	11.70	11.85
H1	6.03	6.18	6.33
H2	6.85	7.00	7.15
H3	3.00 BSC		
L	1.55	1.70	1.85
L1	0.55	0.7	0.85
L2	0.45	0.6	0.75
M	0.08 REF.		
$\beta$	8°	10°	12°
K	4.25	4.40	4.55